Design for Consecutive Transparency of RTL Circuits

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Abstract

This paper presents a design-for-consecutive-transparency method that makes a core (RTL circuit) consecutively transparent using integer linear programming. Consecutive transparency of a core guarantees consecutive propagation of arbitrary test/response sequences from the core inputs to the core outputs with some latency. Therefore, it is possible to apply/observe arbitrary test/response sequences to/from an embedded core consecutively at the speed of system clock by using interconnects and consecutively transparent cores in an SoC. Experimental results show that the proposed method introduces lower area overhead compared to the bypass method that adds direct paths from PIs to POs with multiplexers.

keywords: *design for testability, systems-on-a-chip, test access mechanism, consecutive transparency, consecutive testability, register transfer level*

1 Introduction

A fundamental change has taken place in the way digital systems are designed by making it possible to design an entire system, containing millions of transistors, on a single chip. In order to cope with the growing complexity of such systems, designers often use pre-designed, reusable megacells known as cores. Core-based systems-on-a-chip (SoC) design strategies help companies significantly reduce the time-to-market and design cost for their new products.

However, it is difficult to test SoCs after fabrication[1]. In order to make an SoC testable, the following three conditions have to be satisfied. (1)*There exist a test pattern source (TPS) and a test response sink (TRS) for each core*. The TPS generates the test patterns for the embedded core and the TRS observes the test responses. The TPS as well as the TRS can be implemented either off-chip or on-chip. (2)*There exists a test access mechanism for each core*. The test access mechanism propagates test patterns and test responses. It can be used for on-chip propagation of test patterns from a TPS to the core-under-test, and for on-chip propagation of test responses from the core-under-test to a TRS. (3)*Interconnects that exist between cores are testable*.

A major problem to make an SoC testable concerns accessibility of embedded cores. Several design-for-testability (DFT) techniques have been proposed. There are three main approaches to achieve accessibility of embedded cores. The first approach is based on *test bus architectures* by which the cores are isolated from each other in test mode using a dedicated bus [4, 5, 6, 7, 8] or flexible *TESTRAIL* [9] around the cores to propagate test data. The second approach uses *boundary scan architectures* [2, 3] to isolate the core during test. The third approach uses *transparency* [11, 12, 13, 10] for embedded cores to reduce the problem to one of finding paths from TPS to core inputs and from core outputs to TRS.

Under the design environment for SoCs, pre-computed test sets are provided for each core. These test sets may contain functional vectors, scan vectors or ordered test sequences for non-scan designed sequential circuits. They may be for logic faults such as stuck-at faults or timing faults such as delay faults. Moreover, some cores may be able to be at-speed testable in order to increase the coverage of non-modeled and performance-related defects. For that reason, it is necessary to apply an arbitrary test sequence to each core and observe its response sequence from the core consecutively at the speed of the system clock. We call such a test access *consecutive test access*. Although the test bus approach allows consecutively test access for cores, it does not guarantee consecutive test access for interconnects. On the other hand, boundary scan and transparency approaches allow test access for both cores and interconnect. However, they do not support consecutive test access.

There are two works [14, 15] realizing the consecutive test access for both cores and interconnects. In [14], we proposed a kind of testability of SoCs called *consecutive testability*. A consecutively testable SoC consists of *consecutively transparent* cores and can achieve consecutive test access to all cores and all interconnects (Figure 1). Consecutive transparency of a core guarantees consecutive propagation of arbitrary test/response sequences from the core inputs to the core outputs with some latency. Therefore, it is possible to apply/observe arbitrary test/response sequences to/from an embedded core consecutively at the speed of system clock by using interconnects and consecutively transparent cores in an SoC. In [15], a synthesis-for-transparency
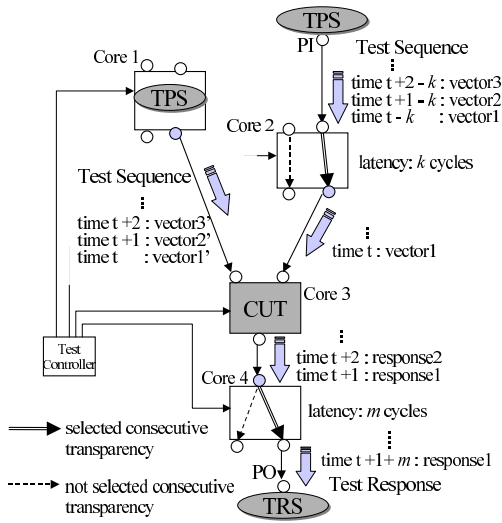
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Figure 1. Consecutive test access for core3

Figure 2. An RTL circuit

approach was presented to make cores *single-cycle transparent* by embedding multiplexers. This single-cycle transparency is a special case of consecutive transparency of [14] such that the latency of the consecutive transparency is restricted to zero, i.e., single-cycle transparency is the consecutive transparency with zero latency. Therefore, the area overhead for making cores consecutively transparent with some latency can be generally lower than that for making cores single-cycle transparent (i.e., transparent with zero latency).

In this paper, we consider a core as a register transfer level (RTL) circuits, and propose a design-for-consecutive-transparency (DFCT) method that makes a core consecutively transparent using integer linear programming (ILP). The DFCT method realizes consecutive transparency with low area overhead by utilizing paths that exist in data path part of an RTL circuit. It is possible to realize consecutive transparency to add bypass routes from PIs to POs with multiplexers independently of internal structure of an RTL circuit. Experimental results show that the proposed method introduces lower area overhead compared to the bypass method.

The rest of this paper is organized as follows. Section 2 gives the definitions of consecutive transparency and RTL circuits. In section 3, we introduce the design-for-consecutive-transparency method. Experimental results are discussed in section 4. Finally, section 7 concludes this paper.

2 Preliminaries

2.1 RTL Circuits

In RTL description, a circuit generally consists of a controller and a data path as shown in Figure 2. The former is represented by 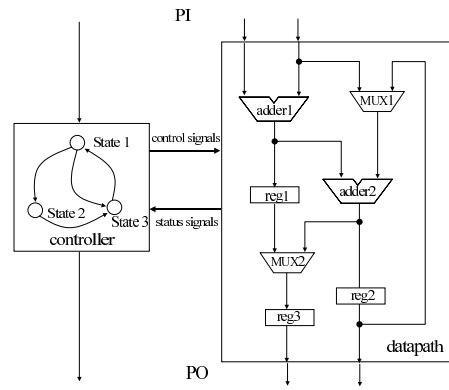a finite state machine (FSM) and the latter is represented by hardware elements (e.g. registers, multiplexers (MUXes) and operational modules) and signal lines connecting them. Each of the controller and the data path has *primary inputs* from the outside of the circuit and *primary outputs* to the outside of the circuit. The controller also has *status inputs* from the data path and *control outputs* to the data path. Similarly, the data path also has *control inputs* from the controller and *status outputs* to the controller. The signals from the controller to the data path are called *control signals*, and the signals from the data path to the controller are called *status signals*.

A data path consists of *hardware elements* and *signal lines*. Hardware elements are primary inputs (PIs), primary outputs (POs), control inputs, status outputs, registers, MUXes and operational modules. We introduce *ports* of each hardware element as interface points in a natural fashion: signals enter into a hardware element through its *input ports*, and exit through its *output ports*. Input ports of a hardware element can be classified into *data input ports* and *control input ports*. Similarly, output ports of a hardware element can be classified into *data output ports* and *status output ports*. A signal line connects two ports with some bit width. Any number of signal lines can connect to the same output port (i.e. fanout is allowed), but only one signal line can connect to the same input port. In order to simplify the discussion, the following restrictions are introduced into data path architecture. (1)All signal lines have the same bit width. (2)Control input ports of a hardware element are connected directly to control inputs of the data path. And status output ports of a hardware element are connected directly to status outputs of the data path.

2.2 Port Graph

Definition 1 *Port Graph*
We define a port graph $G = (V, E)$ as a directed graph to represent an RTL circuit.

- $V = V_{PI} \cup V_{PO} \cup V_{port}$ *where*
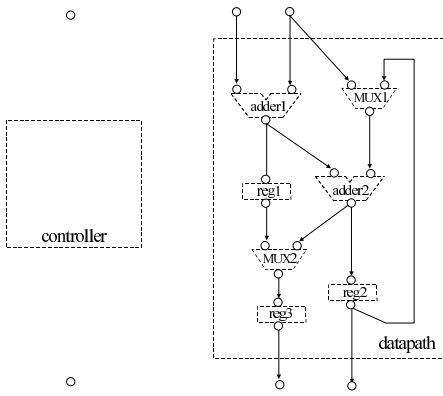 V_{PI} *is the set of all PIs in the RTL circuit,*

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Figure 3. A port graph

Figure 4. Fix control signal on desired value

Figure 5. Thru function

V_{PO} *is the set of all POs in the RTL circuit,*
V_{port} *is the set of all ports in the RTL circuit.*

- $E = \{(x,y) \in V \times V\}$ ■

Figure 3 illustrates a port graph corresponding to an RTL circuit as shown in Figure 2.

2.3 Consecutive Transparency of a Core (RTL circuit)

Definition 2 *Consecutive transparency of a core*
Let $I(i)$ be the ith bit of a PI I, and $O(j)$ be the jth bit of a PO O. Suppose that there exists a configuration (test mode) of a core which can realize a path P between $I(i)$ and $O(j)$. P is called a consecutively transparent path if any input sequence applied to $I(i)$ can be consecutively observed at $O(j)$ after some latency, and then $I(i)$ and $O(j)$ are said to be consecutively transparent. Moreover, a core is called to be consecutively transparent if, for each PI/PO of the core, there exists a configuration that can make all bits of the port consecutively transparent. ■

3 Design for Consecutive Transparency

In this section, we present a design-for-consecutive-transparency (DFCT) method that makes an RTL circuit consecutively transparent using integer linear programming.

3.1 Problem Formulation

A consecutively transparent circuit has consecutively transparent paths for each PIs and POs. When a given RLT circuit does not have such paths for each PIs(POs), DFCT elements are added in order to make the circuit consecutively transparent as follows.

Case I : There exits a path from the PI(PO) to a PO(PI) through a MUX or register, and normal operational mode (control signals from controller) can not propagate an arbitrary sequence through the path due to hold behavior of the register or switching behavior of MUX.
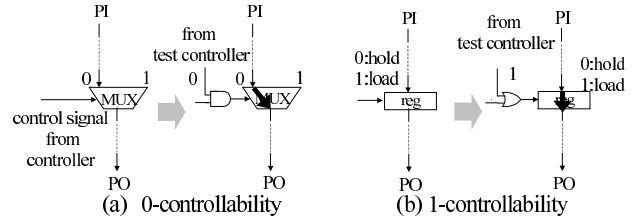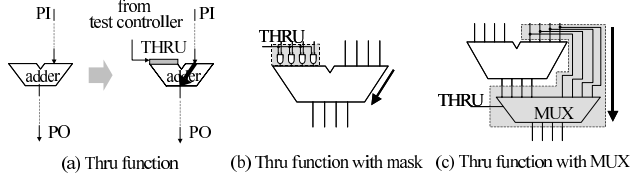
DFCT elements: AND gate, OR gate and MUX

In order to propagate an arbitrary sequence through the path, we fix the control signal (from controller to the MUX or register) on the desired value by DFCT elements as follows (Figure 4).

- In case 0-controllability is necessary on the control signal, an AND gate is added to the control signal.
- In case 1-controllability is necessary on the control signal, an OR gate is added to the control signal.
- In case general-controllability is necessary on the control signal, an MUX is added to the control signal.

Case II : There exits a path from the PI(PO) to a PO(PI) through an operational module, and the path can not propagate an arbitrary sequence.

DFCT element: thru function

In order to propagate an arbitrary sequence through the path, we augment the module with thru function if necessary (Figure 5).

Case III : There exits no path from the PI(PO) to a PO(PI).

DFCT element: MUX

In order to propagate an arbitrary sequence from the PI(PO) to a PO(PI), we add a direct path from the PI(PO) to a PO(PI) with MUX (Figure 6).

Added DFCT elements are controlled by signals from a *test controller*. Figure 7 shows a test architecture of the proposed method. In this figure, 0-controllability of MUX1, thru function of adder2 and 1-controllability of reg2 are added, and a consecutively transparent path (shaded line) is realized by the control signal from the test controller.
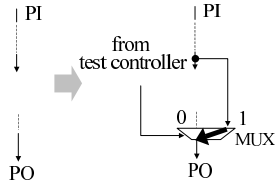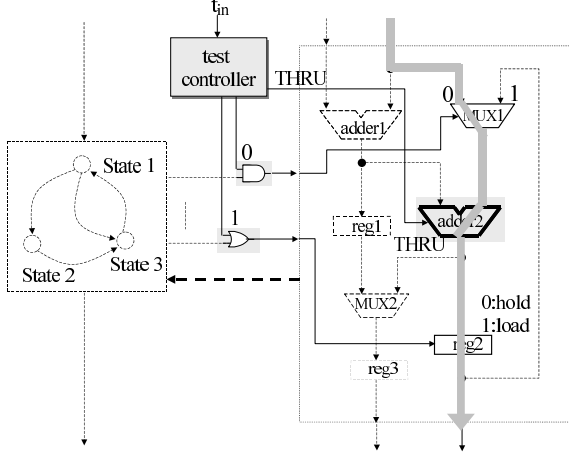
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Figure 6. Addition of a path with MUX

Figure 7. Test architecture of the proposed method

Definition 3 *The design for consecutive transparency (DFCT) is formulated as the following optimization problem.*
Input*: An RTL circuit (a port graph)*
Output*: A consecutively transparent RTL circuit*
Optimization*: Minimizing hardware overhead (i.e., hardware of added DFCT elements)* ∎

3.2 DFCT Algorithm

In this subsection, we propose a DFCT algorithm. The algorithm consists of the following two steps.

Step 1 For a given port graph (an RTL circuit), add edges which can be realized by DFCT elements.

Step 2 For each PI and PO, induce constraints such that the PI (PO) has a consecutively transparent path, and formulate DFCT as an ILP problem to minimize hardware overhead.

Step 1: Addition of edges to a port graph
For a port graph, the algorithm adds edges and vertices as follows (Figure 8).

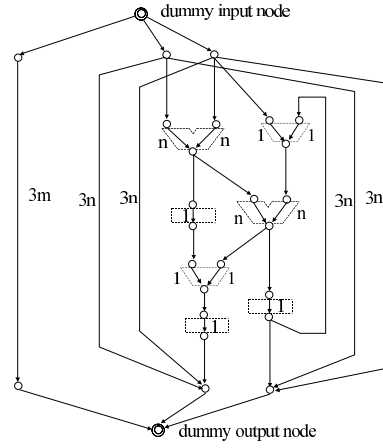- a dummy input vertex and edges from the dummy input vertex to all $v \in V_{PI}$

Figure 8. Addition of edges and cost to a port graph

- a dummy output vertex and edges from all $v \in V_{PO}$ to the dummy input vertex

- edges from data input ports of a MUX to a data output port of the MUX (These edges are realized by AND gates for 0-controllability, OR gates for 1-controllability, and MUXes for general-controllability.)

- edges from data input ports of a operational module to a data output port of the operational module (These edges are realized by thru functions.)

- edges from a data input port of a register to a data output port of the register (These edges are realized by AND gates for 0-controllability, OR gates for 1-controllability, and MUXes for general-controllability.)

- edges from each PI to all PO in data path (These edges are realized by MUXes.)

- edges from each PI to all PO in controller (These edges are realized by MUXes.)

Then, the algorithm defines cost of each edge as the hardware cost that is necessary to realize the edge by DFCT elements (i.e. AND gate, OR gate, thru function and MUX), and defines capacity of each edge as 1. Figure 8 shows , examples of the hardware costs when all signal lines in the data path have n bit width.

Step 2: An ILP formulation for DFCT
For the port graph extended in Step 1, DFCT is formulated as an ILP problem represented by equations (1) to (8) with the following 0-1 variables.

$$x_{v,e} = \begin{cases} 1 & \text{Edge } e \in E \text{ is used as a part of consecutively transparent path for port } v \in V_{PI} \cup V_{PO}. \\ 0 & \text{otherwise} \end{cases}$$

$$x_e = \begin{cases} 1 & \text{Edge } e \in E \text{ is used as a part of} \\ & \text{consecutively transparent path for} \\ & \text{more than one port } v \in V_{PI} \cup V_{PO}. \\ 0 & \text{otherwise} \end{cases}$$

Minimize:

$$\sum_{e \in E} x_e \cdot cost(e) \tag{1}$$

$cost(e)$ is a constant value which represents the hardware cost to realize edge e with a DFCT element.

Subject to:

1. For each PI $v_{pi} \in V_{PI}$,

$$1 = \sum_{e \in E_{v_{pi}}^{out}} x_{v_{pi},e} \tag{2}$$

$$\sum_{e \in E_{v_{do}}^{in}} x_{v_{pi},e} = 1 \tag{3}$$

$$\sum_{e \in E_v^{in}} x_{v_{pi},e} = \sum_{e \in E_v^{out}} x_{v_{pi},e} \tag{4}$$
$$\text{for all } v \in V - \{v_{pi}\} - \{v_{do}\}$$

v_{di} and v_{do} denote dummy input vertex and dummy output vertex, respectively. E_v^{in} and E_v^{out} denote the set of all input edges and the set of all output edges, respectively.

2. For each PO $v_{po} \in V_{PO}$,

$$1 = \sum_{e \in E_{v_{di}}^{out}} x_{v_{po},e} \tag{5}$$

$$\sum_{e \in E_{v_{po}}^{in}} x_{v_{po},e} = 1 \tag{6}$$

$$\sum_{e \in E_v^{in}} x_{v_{po},e} = \sum_{e \in E_v^{out}} x_{v_{po},e} \tag{7}$$
$$\text{for all } v \in V - \{v_{di}\} - \{v_{po}\}$$

3. For each edge $e \in E$,

$$x_e \geq x_{v,e} \qquad \text{for all } v \in V \tag{8}$$

Equations (2), (3) and (4) are constraints such that the port graph has flow of value 1 from PI v_{pi} to dummy output vertex v_{do}. For each vertex, these equations guarantee that the sum of input flows is equal to the sum of output flow. Similarly, equations (5), (6) and (7) are constraints such that the port graph has flow of value 1 from dummy input vertex

Table 1. Characteristics of RTL Benchmark Circuits

Circuits	Controller		Datapath			Area
	#PI	#PO	|bit|	#PI	#PO	(#gates)
GCD	1	1	16	2	1	2384
JWF	1	0	16	5	5	10169
LWF	1	0	16	2	2	3377
Paulin	1	0	32	2	2	36203

v_{di} to PO v_{po}. Equations (1) and (8) minimize hardware overhead. We can find consecutively transparent paths for all PIs and POs with minimum hardware overhead by the solving above ILP problem, and DFCT elements are added to realize those paths.

In this paper, we showed the method to minimize hardware overhead only. However, we can avoid delay overhead by making costs of the edges in critical paths of a circuit high.

4 Experimental Results

In this section, we present experimental results obtained by the proposed method. Circuit characteristics of RTL benchmark circuits used in the experiments are shown in Table 1. These circuits are examples used popularly. In our experiments, we used Design Compiler (Synopsys) to synthesize those benchmark circuits. In this table, columns "#PI" and "#PO" of columns "Controller" and "Datapath" denote the number of PIs and POs of respective parts. Column "|bit|" denotes the bit width of data paths. Column "Area" denotes the total area after synthesis. Here, areas are estimated using gate equivalent of library cell area.

The area and pin overhead of the proposed method are shown in Table 2. We used the *lp_solve* package from Eindhoven University of Technology [16]. The running time is negligible (less than 0.1 second) for all four benchmark circuits on a SUN Ultra 5 workstation. Columns "Thru", "Bypass MUX", "Controllability for control signal" and "Test controller" in column "Proposed" of column "Area overhead" denote the area overhead of the proposed method added by thru functions, bypass MUXes, primitive gates on control signal and test controller, respectively. Column "Bypass MUX only" of column "Area overhead" denotes the area overhead of the bypass method that adds direct paths from PIs to POs with MUXes.

From the experimental results, we can see that the proposed method introduces lower area overhead compared to the bypass method in all circuits. In the proposed method, we can guarantees that a consecuitvely transparent path for each PI/PO can be realized by adding at most one MUX since we consider utilization of existing paths in data path as well as addition of bypass routes with MUXes. Column "Pin overhead" in Table 2 denotes the number of additional pins for consecutive transparency. In proposed method, we

Table 2. Hardware Overhead

Circuits	Area overhead (%)						Pin overhead
	Proposed					Bypass MUX only	
	Thru	Bypass MUX	Controllability for control signal	Test controller	Total		
GCD	0	0.38	1.38	1.22	2.98	10.11	3
JWF	1.26	0.09	0.74	1.09	3.18	6.62	4
LWF	3.79	0.27	0.47	0.56	5.09	7.88	3
Paulin	0.35	0.67	0.04	0.09	1.15	1.38	3

need $\lceil \log_2 n + 1 \rceil$ additional pins. Here, n is a total number of PIs and POs of a circuit. These additional pins are used for identifying modes of the circuit (i.e. normal mode and consecutively transparent modes (configurations)). Since circuits are embedded into an SoC as cores, those additional pins of the circuits for consecutive transparency do not result in pin overhead of the SoC directly.

5   Conclusions

In this paper, we proposed a design-for-consecutive-transparency method that makes an RTL circuit consecutively transparent using integer linear programming. The DFCT method realizes consecutive transparency with low area overhead (average 3.1%) by utilizing paths that exist in data path of an RTL circuit. Experimental results show that the proposed method introduces lower area overhead compared to the bypass method. Consecutive transparency of a core guarantees consecutive propagation of arbitrary test/response sequences from the core inputs to the core outputs with some latency. Therefore, it is possible to apply/observe arbitrary test/response sequences to/from an embedded core consecutively at the speed of system clock by using interconnects and consecutively transparent cores in an SoC.

Acknowledgments

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